

Thyristor/Diode Modules M## 325

Absolute Maximum Ratings

V _{RRM} V _{DRM} [V]			
1400 1800	325-14io3 325-18io3	325-14io3 325-18io3	325-14io3 325-18io3

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{DRM}	Repetitive peak off-state voltage ¹⁾	1400-1800	V
V _{DSDM}	Non-repetitive peak off-state voltage ¹⁾	1500-1900	V
V _{RRM}	Repetitive peak reverse voltage ¹⁾	1400-1800	V
V _{RSM}	Non-repetitive peak reverse voltage ¹⁾	1500-1900	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{T(AV)M}	Maximum average on-state current, T _C = 85°C ²⁾	345	A
I _{T(AV)M}	Maximum average on-state current, T _C = 100°C ²⁾	255	A
I _{T(RMS)M}	Nominal RMS on-state current, T _C = 55°C ²⁾	785	A
I _{T(d.c.)}	D.C. on-state current, T _C = 55°C	640	A
I _{TSM}	Peak non-repetitive surge t _p = 10 ms, V _{RM} = 60%V _{RRM} ³⁾	7.65	kA
I _{TSM2}	Peak non-repetitive surge t _p = 10 ms, V _{RM} ≤ 10 V ³⁾	8.50	kA
I ² t	I ² t capacity for fusing t _p = 10 ms, V _{RM} = 60%V _{RRM} ³⁾	293×10 ³	A ² s
I ² t	I ² t capacity for fusing t _p = 10 ms, V _{RM} ≤ 10 V ³⁾	361×10 ³	A ² s
(di/dt) _{cr}	Critical rate of rise of on-state current (repetitive) ⁴⁾ Critical rate of rise of on-state current (non-repetitive) ⁴⁾	250 500	A/μs A/μs
V _{RGM}	Peak reverse gate voltage	5	V
P _{G(AV)}	Mean forward gate power	3	W
P _{GM}	Peak forward gate power	30	W
V _{ISOL}	Isolation Voltage ⁵⁾	3000	V
T _{vj op}	Operating temperature range	-40 to +130	°C
T _{stg}	Storage temperature range	-40 to +130	°C

Notes:

- 1) De-rating factor of 0.13% per °C is applicable for T_{vj} below 25°C.
- 2) Single phase; 50 Hz, 180° half-sinewave.
- 3) Half-sinewave, 130°C T_{vj} initial.
- 4) V_D = 67% V_{DRM}, I_{TM} = 700A, I_{FG} = 6 A, di/dt = 1A/μs, T_C = 130°C.
- 5) AC RMS voltage, 50 Hz, 1min test

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS ¹⁾	UNITS
V_{TM}	Maximum peak on-state voltage	-	-	0.91	$I_{TM} = 350 \text{ A}$	V
V_{TM}	Maximum peak on-state voltage	-	-	1.25	$I_{TM} = 1000 \text{ A}$	V
V_{TO}	Threshold voltage	-	-	0.75		V
r_T	Slope resistance	-	-	0.50		$\text{m}\Omega$
$(dv/dt)_{cr}$	Critical rate of rise of off-state voltage	1000	-	-	$V_D = 67\% V_{DRM}$, linear ramp, Gate o/c	$\text{V}/\mu\text{s}$
I_{DRM}	Peak off-state current	-	-	40	Rated V_{DRM}	mA
I_{RRM}	Peak reverse current	-	-	40	Rated V_{RRM}	mA
V_{GT}	Gate trigger voltage	-	-	2.0		V
I_{GT}	Gate trigger current	-	-	150	$T_{vj} = 25^\circ\text{C}$, $V_D = 12 \text{ V}$, $I_T = 3 \text{ A}$	mA
V_{GD}	Gate non-trigger voltage	0.25	-	-	67% V_{DRM}	V
I_L	Latching current	-	-	700	$V_D = 12 \text{ V}$, $T_{vj} = 25^\circ\text{C}$	mA
I_H	Holding current	-	-	300	$V_D = 12 \text{ V}$, $T_{vj} = 25^\circ\text{C}$	mA
t_{gd}	Gate controlled turn-on delay time	-	-	2.0	$I_{FG} = 6 \text{ A}$, $di_G/dt = 1 \text{ A}/\mu\text{s}$, $V_D = 40\%V_{DRM}$, $I_{TM} = 350 \text{ A}$, $di/dt = 10 \text{ A}/\mu\text{s}$, $T_{vj} = 25^\circ\text{C}$	μs
Q_{rr}	Recovered Charge	-	-	1450		μC
Q_{ra}	Recovered Charge, 50% chord	-	-	1200	$I_{TM} = 320 \text{ A}$, $t_p = 1 \text{ ms}$, $di/dt = 10 \text{ A}/\mu\text{s}$, $V_R = 100 \text{ V}$	μC
I_{rm}	Reverse recovery current	-	-	120		A
t_{rr}	Reverse recovery time, 50% chord	-	-	20		μs
t_q	Turn-off time	-	-	160	$I_{TM} = 320 \text{ A}$, $t_p = 1 \text{ ms}$, $di/dt = 10 \text{ A}/\mu\text{s}$, $V_R = 100 \text{ V}$, $V_{DR} = 67\%V_{DRM}$, $dv_{DR}/dt = 50 \text{ V}/\mu\text{s}$	μs
R_{thJC}	Thermal resistance, junction to case	-	-	0.110	Single Thyristor	K/W
		-	-	0.055	Whole Module	K/W
R_{thCH}	Thermal resistance, case to heatsink	-	-	0.04	Single Thyristor	K/W
		-	-	0.02	Whole Module	K/W
F_1	Mounting force (to heatsink)	5.10	-	6.90		Nm
F_2	Mounting force (to terminals)	7.65	-	10.35 ²⁾		Nm
W_t	Weight	-	800	-		g

Notes:1) Unless otherwise indicated $T_{vj}=130^\circ\text{C}$.

2) Screws must be lubricated.

Notes on Ratings and Characteristics**1.0 Voltage Grade Table**

Voltage Grade	V_{DRM} V	V_{RSM} V	V_D DC V	V_R DC V
12	1200	1300	900	
14	1400	1500	1050	
16	1600	1700	1200	
18	1800	1900	1350	

2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/ $^{\circ}\text{C}$ is applicable to this device for T_{vj} below 25 $^{\circ}\text{C}$.

4.0 Repetitive dv/dt

Standard dv/dt is 1000V/ μs .

5.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

6.0 Rate of rise of on-state current

The maximum un-primed rate of rise of on-state current must not exceed 500A/ μs at any time during turn-on on a non-repetitive basis. For repetitive performance, the on-state rate of rise of current must not exceed 250A/ μs at any time during turn-on. Note that these values of rate of rise of current apply to the total device current including that from any local snubber network.

7.0 Computer Modelling Parameters**7.1 Thyristor Dissipation Calculations**

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^2 + 4 \cdot ff^2 \cdot r_T \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \quad \text{and:} \quad W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j\max} - T_C$$

Where $V_{T0} = 0.75$ V, $r_T = 0.50$ m Ω .

R_{th} = Supplementary thermal impedance, see table on next page and

ff = Form factor, see table on next page.

Supplementary Thermal Impedance							
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave	0.1170	0.1163	0.1156	0.1150	0.1137	0.1119	0.1100
Sine wave	0.1165	0.1156	0.1150	0.1142	0.1123		

Form Factors							
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave	3.464	2.449	2.000	1.732	1.414	1.149	1.000
Sine wave	3.980	2.778	2.220	1.879	1.570		

7.2 Calculating thyristor V_T using ABCD Coefficients

The on-state characteristic I_T vs. V_T , on page 6 is represented by a set of constants A, B, C, D, forming the coefficients of the representative equation for V_T in terms of I_T given below:

$$V_T = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for V_T agree with the true device characteristic over a current range, which is limited to that plotted.

25°C Coefficients		125°C Coefficients	
A	0.9377735	A	0.5178489
B	0.02863417	B	0.0409915
C	3.40709×10^{-4}	C	4.59674×10^{-4}
D	2.08604×10^{-4}	D	-2.65973×10^{-4}

8.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}} \right)$$

Where $p = 1$ to n and:

- n = number of terms in the series
- t = Duration of heating pulse in seconds
- r_t = Thermal resistance at time t
- r_p = Amplitude of p th term
- τ_p = Time Constant of r_p th term

The coefficients for this device are shown in the table below:

D.C.				
Term	1	2	3	4
r_p	0.06311777	0.01445992	0.0202182	0.01254488
τ_p	2.815199	0.6437661	0.09192482	0.02995412

9.0 Reverse recovery ratings

- (i) Q_{ra} is based on 50% I_{RM} chord as shown in Fig. 1

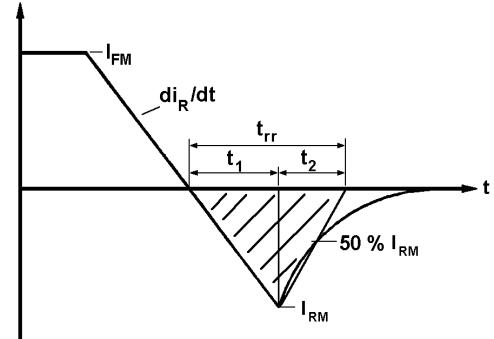


Fig. 1

- (ii) Q_{rr} is based on a 150 μs integration time i.e.

$$Q_{rr} = \int_0^{150\mu s} i_{rr} dt$$

(iii) $K \text{ Factor} = \frac{t_1}{t_2}$

Curves

Figure 1 – On-state characteristics of Limit device

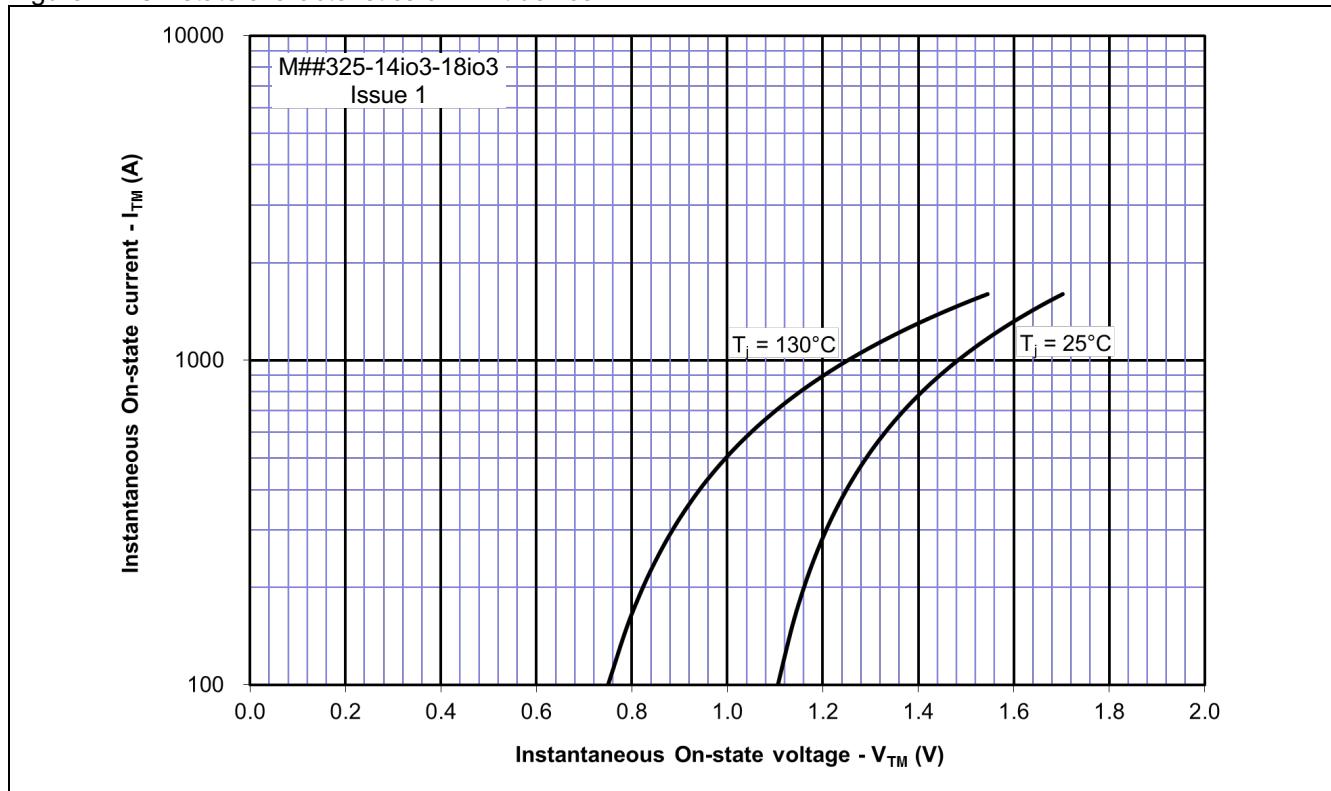


Figure 2 – Gate characteristics – Trigger limits

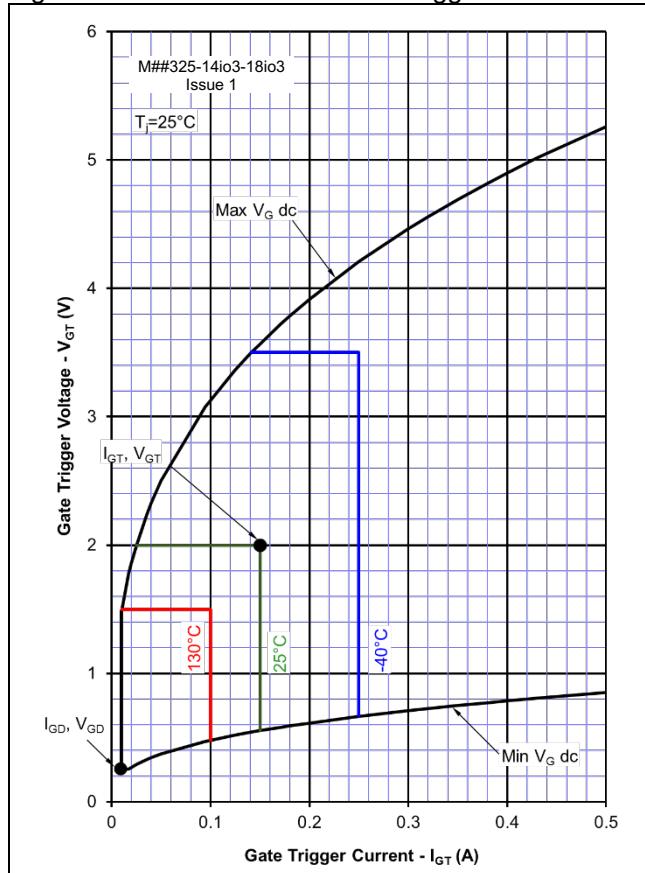


Figure 3 – Gate characteristics – Power curves

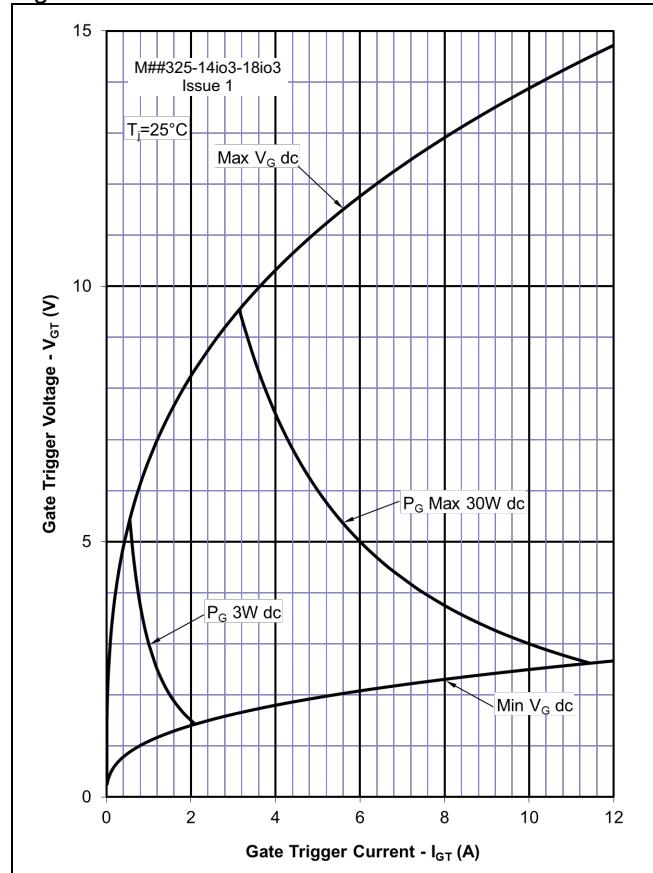


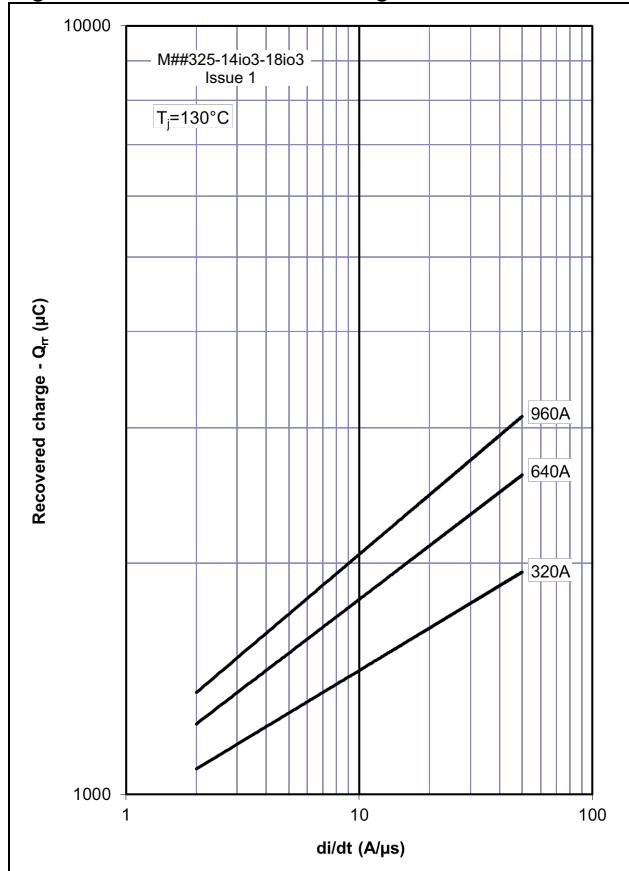
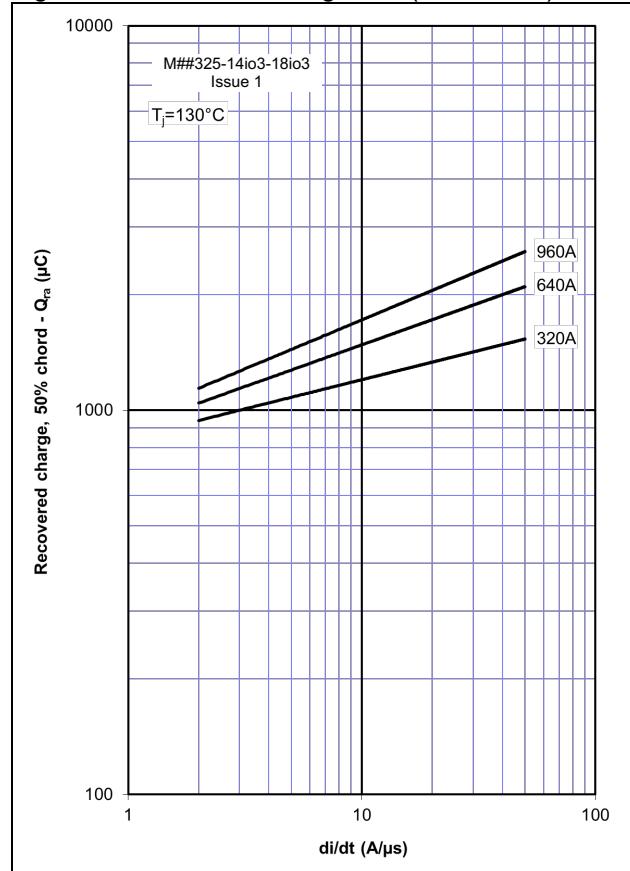
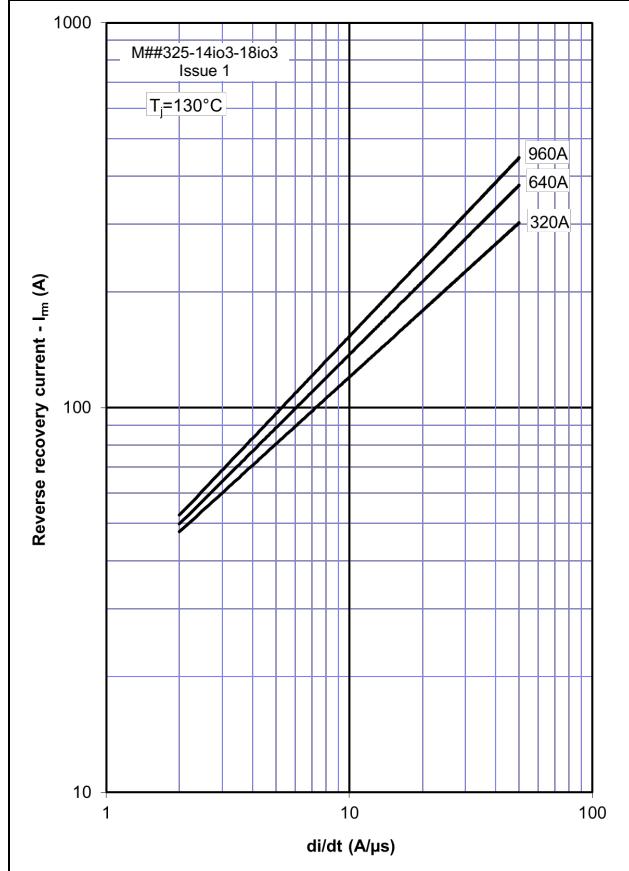
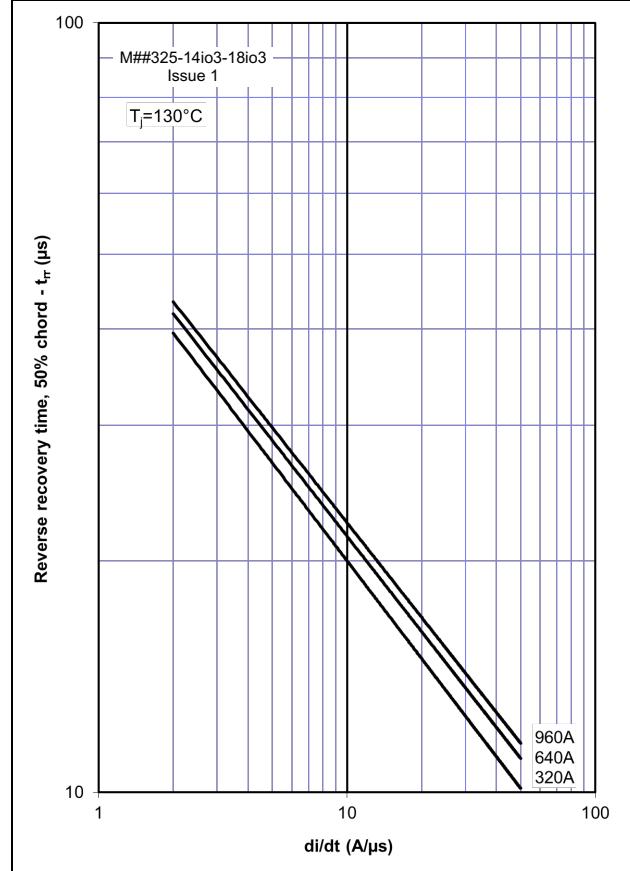
Figure 4 - Total recovered charge, Q_{rr} Figure 5 - Recovered charge, Q_{ra} (50% chord)Figure 6 - Peak reverse recovery current, I_{rm} Figure 7 - Maximum recovery time, t_{rr} (50% chord)

Figure 8 – On-state current vs. Power dissipation – Sine wave

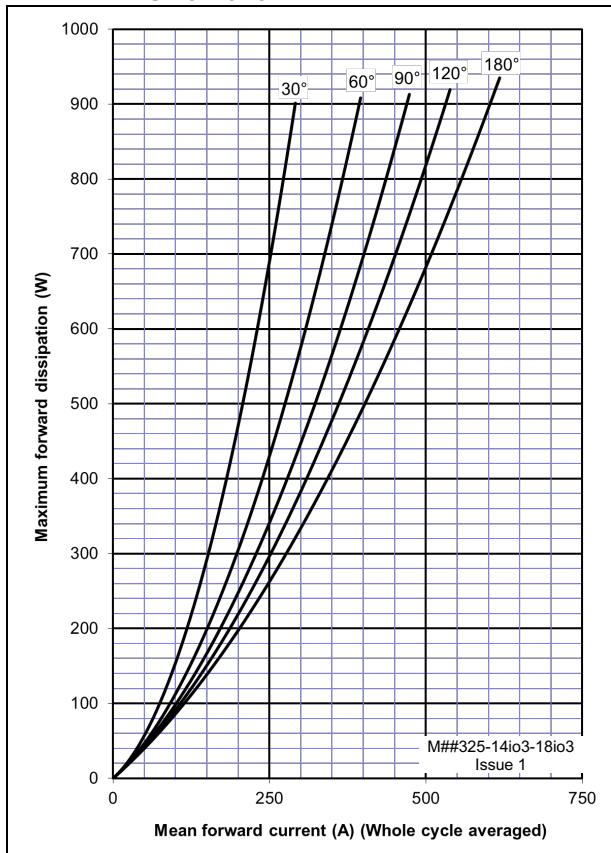


Figure 9 – On-state current vs. Heatsink temperature – Sine wave

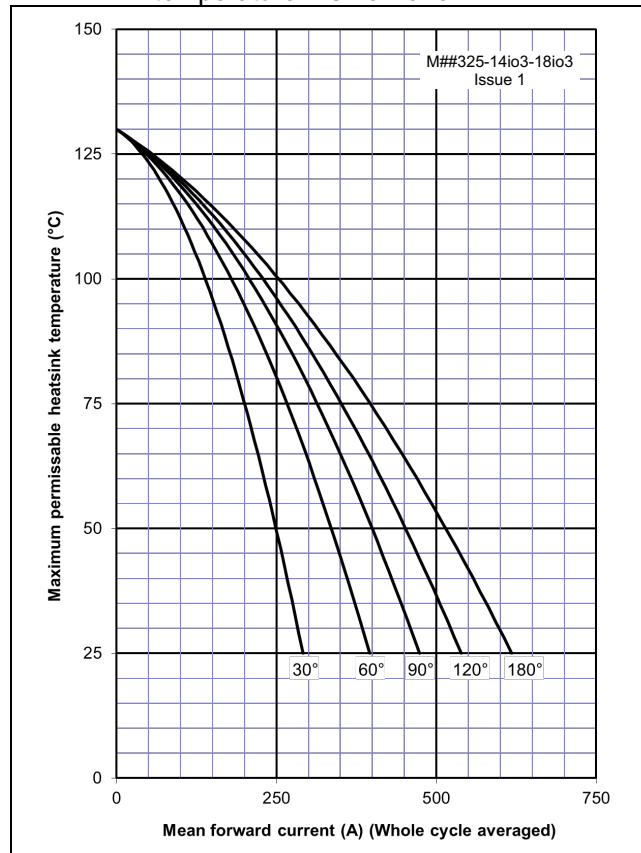


Figure 10 – On-state current vs. Power dissipation – Square wave

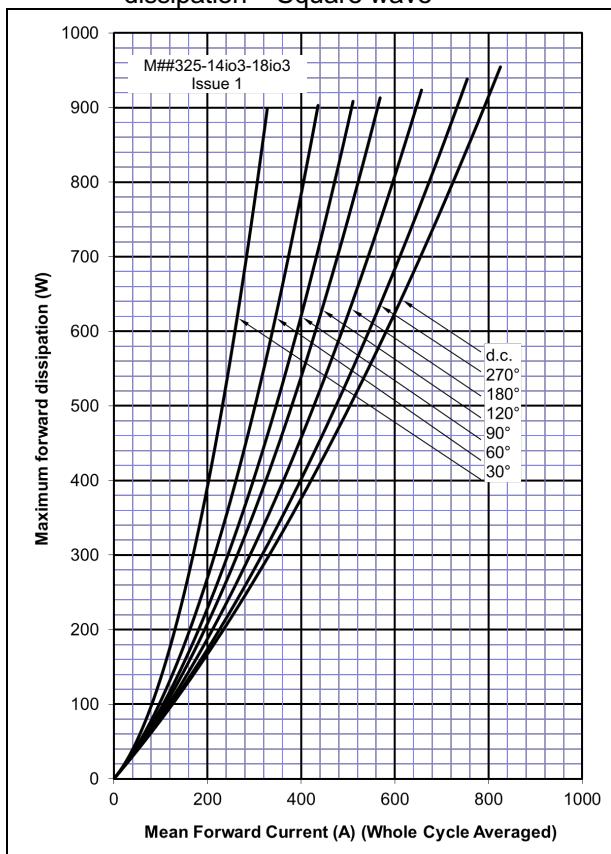


Figure 11 – On-state current vs. Heatsink temperature – Square wave

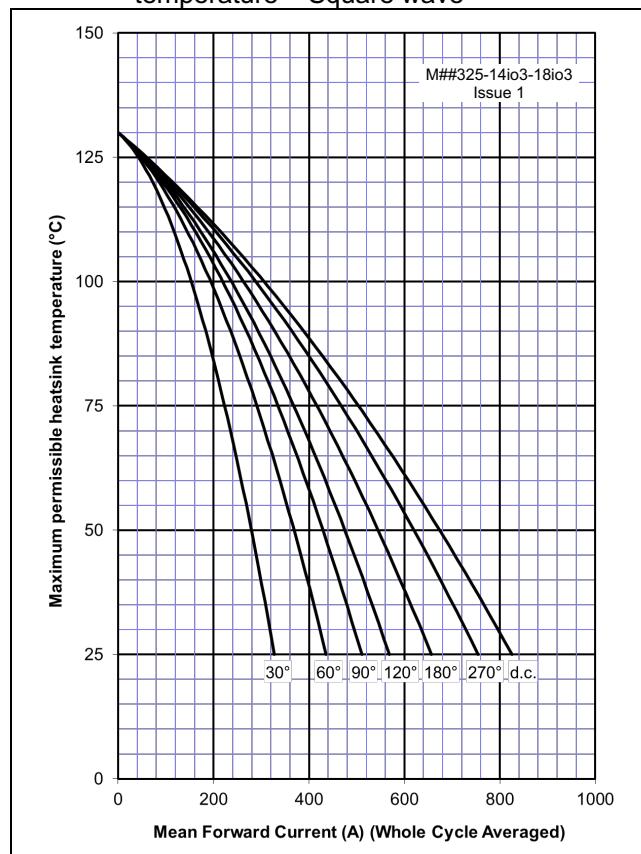


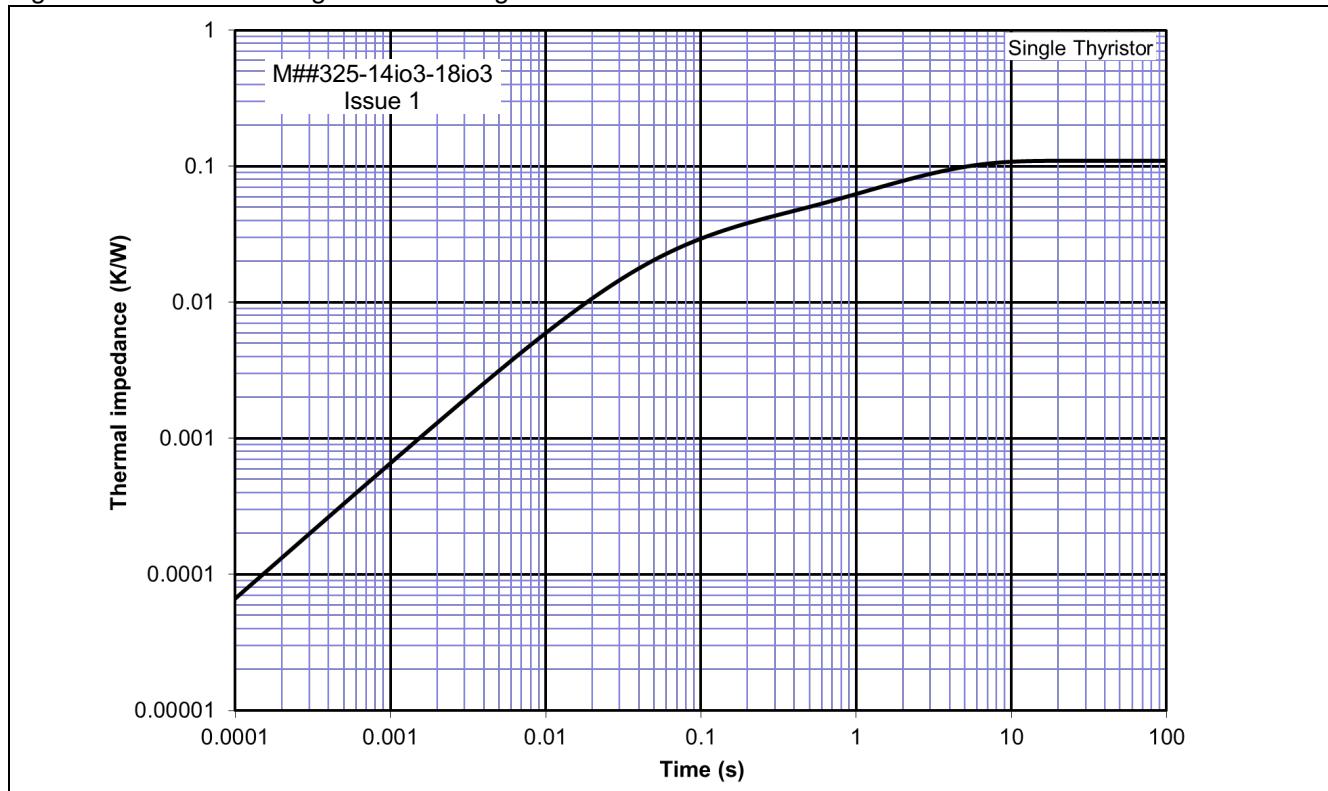
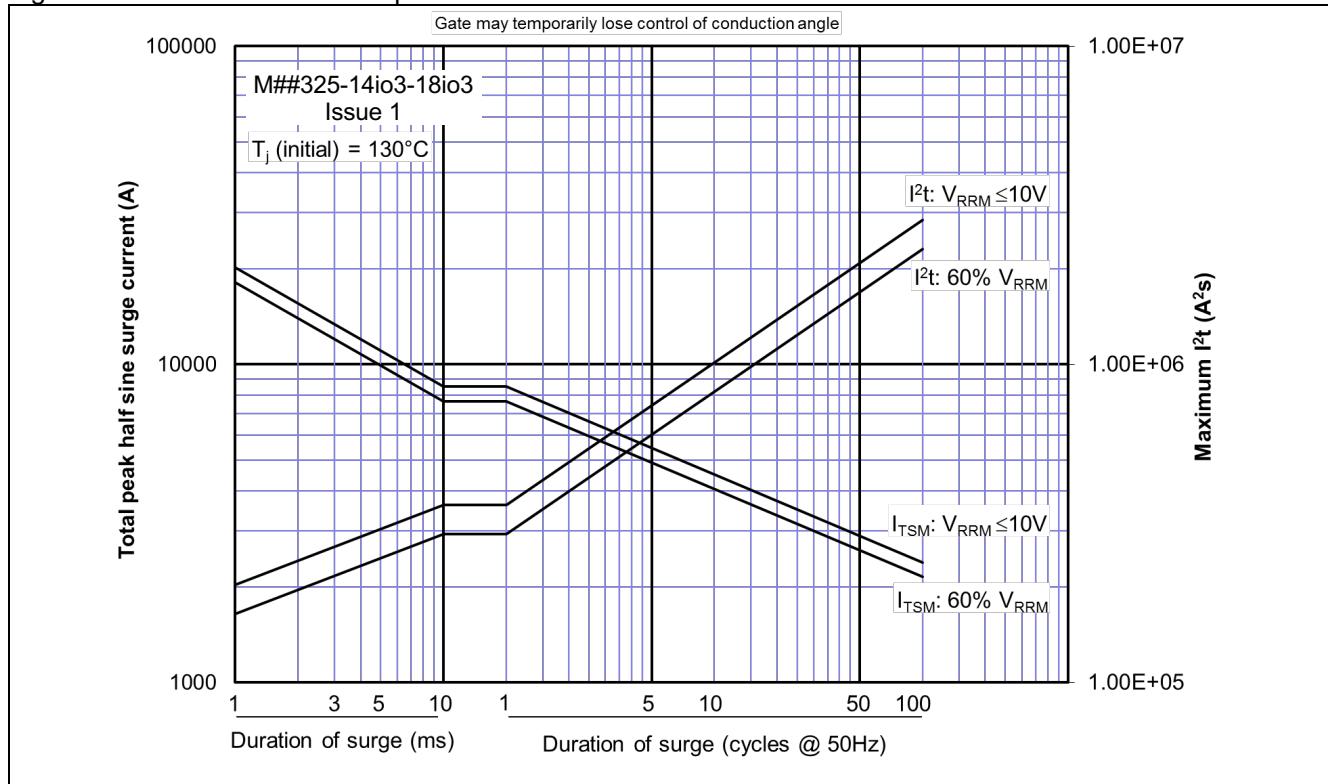
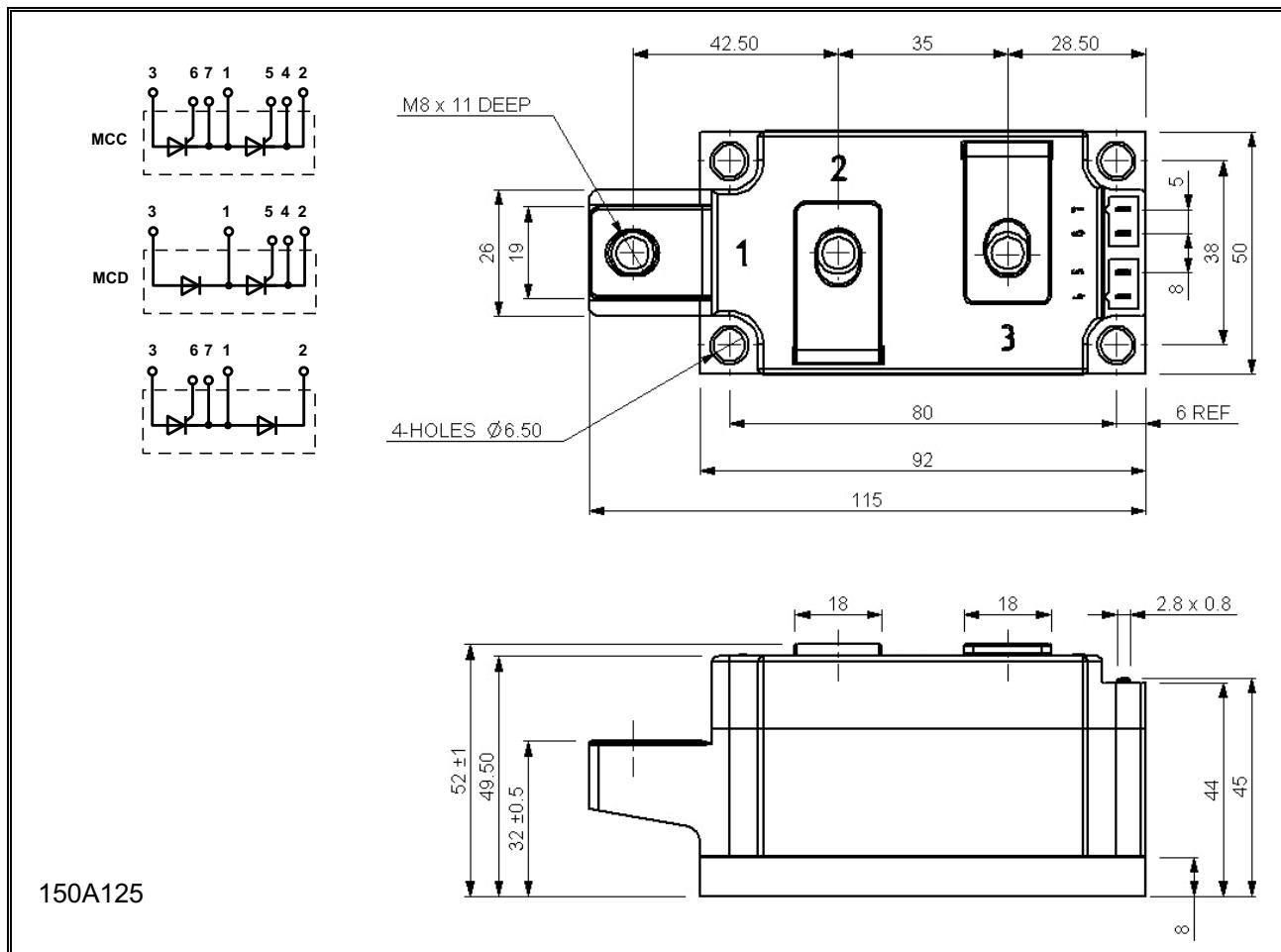
Figure 12 – Maximum surge and I^2t Ratings

Figure 13 – Transient thermal impedance



Outline Drawing & Ordering Information**ORDERING INFORMATION**

(Please quote 11 digit code as below)

M	##	325	♦♦	io	3
Fixed Type Code	Configuration code CC, CD or DC	Fixed Type Code	V _{RRM} /100 14 & 18	i = Critical dv/dt 1000 V/μs o = Typical turn-off time	Fixed Version Code

Typical order code: MCD325-14io3 – MCD configuration, 1400V V_{RRM}

IXYS Semiconductor GmbH
 Edisonstraße 15
 D-68623 Lampertheim
 Tel: +49 6206 503-0
 Fax: +49 6206 503-627
 E-mail: marcom@ixys.de



IXYS UK Westcode Ltd
 Langley Park Way, Langley Park,
 Chippenham, Wiltshire, SN15 1GE.
 Tel: +44 (0)1249 444524
 Fax: +44 (0)1249 659448
 E-mail: sales@ixysuk.com

IXYS Corporation
 1590 Buckeye Drive
 Milpitas CA 95035-7418
 Tel: +1 (408) 547 9000
 Fax: +1 (408) 496 0670
 E-mail: sales@ixys.net

www.ixysuk.comwww.ixys.com

IXYS Long Beach, Inc
 IXYS Long Beach, Inc
 2500 Mira Mar Ave, Long Beach
 CA 90815
 Tel: +1 (562) 296 6584
 Fax: +1 (562) 296 6585
 E-mail: service@ixyslongbeach.com

The information contained herein is confidential and is protected by Copyright. The information may not be used or disclosed except with the written permission of and in the manner permitted by the proprietors IXYS UK Westcode Ltd.

© IXYS UK Westcode Ltd.

In the interest of product improvement, IXYS UK Westcode Ltd reserves the right to change specifications at any time without prior notice.

Devices with a suffix code (2-letter, 3-letter or letter/digit/letter combination) added to their generic code are not necessarily subject to the conditions and limits contained in this report.